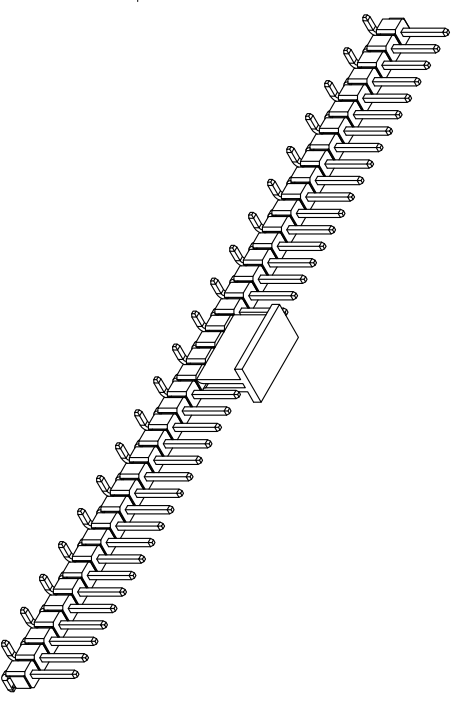
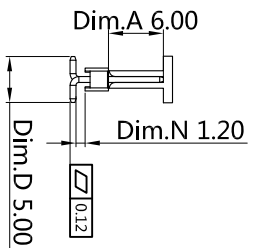
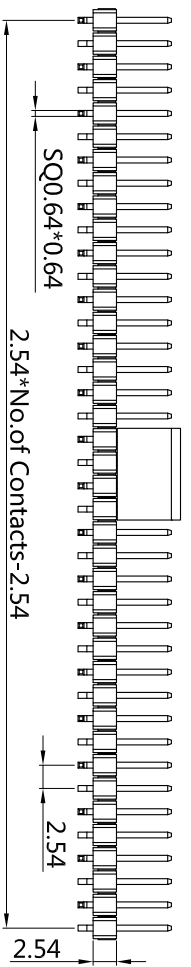
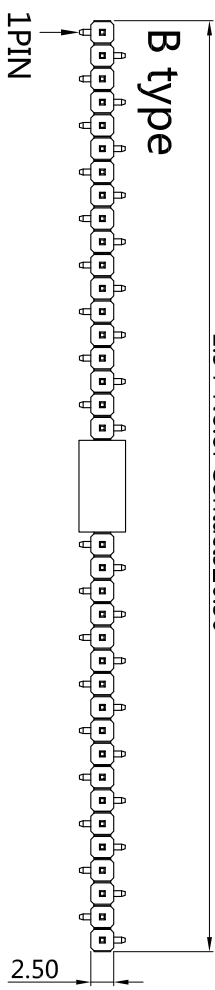
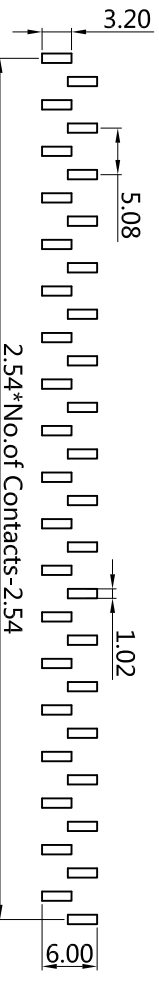


A								8
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Current Rating: 3 Amps
Insulator Resistance: 1000 Megohms min
Dielectric Withstanding: AC 500V
Contact Resistance: 20mΩ MAX
Operation Temperature: -40~+105°C
Max processing temp: 230°C for 60seconds
Max processing temp: 260°C for 10seconds
Contact Material: Brass
Insulator material: Standard: Polyester, UL 94V-0
Standard: PA6T
Finish: Tin Gold Plated
Standard: Gold Flash all over



Recommended P.C. Board
SMD Layout



(RoHS Compliant)
H1 X 25 - 1 XX DB BK X 000 E

- Insulator material:
 - A=PBT N=PA6T
 - L=LCP P=PA9T
 - 2. Circuits:1-40 PIN
 - 3. Tail Style:
 - DA=SMT A Type
 - DB=SMT B Type
 - 4. Color:
 - BK=Black
- Contact Plated:
 - T=Matte Tin over Nickel
 - W=Matte Tin over nickel 150μ"
 - Y=Bright Tin over Nickel
 - F=Gold Flash, Matte Tin 100μ"
 - A=Gold 3μ"
 - B=Gold 3μ"
 - C = ordinary gold plating
 - D = Gold 5μ"
- Special Options:
 - I= Gold 1μ"
 - E=Gold 5μ"
 - G=Gold 10μ"
 - J=Gold 10μ"
 - L = Gold 15μ"
 - M=Gold 15μ"
 - U = Gold 30μ"
 - V=Gold 30μ"
- Packaging:
 - A=Bag
 - B=Tube
 - C=Tray
 - E=Cap+Reel



东莞市震升电子有限公司
 DONG GUAN ZHEN SHENG ELECTRONICS CO., LTD

F	BOM	1: H1N25-140BKHOCL	PART NO.	H1X25-1XXDBKX000E	X	.XX	.XXX
		2: SQ0064-12.2-X-C12	DRAWING NO	ZS-00182-P	±0.30	±0.20	±0.1
F		3:	DRAWN BY	Deng Jin Quan	2021-12-26	SCALE:1:1	ITEM: H1
F			APPROVAL BY	Chen xiao guang	2021-12-28	UNIT: M.M	